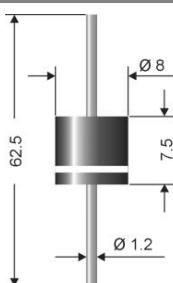


SBH 1520 ... SBH 1545



Axial lead diode

Type	Repetitive peak reverse voltage V_{RRM} V	Surge peak reverse voltage V_{RSM} V	Max. reverse recovery time $I_F = -A$ $I_R = -A$ $I_{RR} = -A$ t_{rr} ns	Max. forward voltage $V_F^2)$
SBH 1520	20	20	-	0,48
SBH 1530	30	30	-	0,48
SBH 1540	40	40	-	0,48
SBH 1545	45	45	-	0,48

High temperature schottky barrier diodes

SBH 1520 ... SBH 1545

Forward Current: 15 A

Reverse Voltage: 20 to 45 V

Features

- Max. solder temperature: 260°C
- Plastic material has UL classification 94V-0
- Electrostatic discharge immunity test IEC 1000-4-2 (C=150 pF, R=150 Ohm): voltage class 20 kV

Mechanical Data

- Plastic case: 8 x 7,5 [mm]
- Weight approx.: 1,5 g
- Terminals: plated terminals solderable per MIL-STD-750
- Mounting position: any
- Standard packaging: 500 pieces per ammo or 1000 pieces per reel

Absolute Maximum Ratings		$T_A = 25^\circ\text{C}$, unless otherwise specified	
Symbol	Conditions	Values	Units
I_{FAV}	Max. averaged fwd. current, R-load, $T_A = 50^\circ\text{C}$ ¹⁾	15	A
I_{FRM}	Repetitive peak forward current $f > 15 \text{ Hz}^1)$	60	A
I_{FSM}	Peak forward surge current 50 Hz half sinus-wave ³⁾	350	A
i^2t	Rating for fusing, $t < 10 \text{ ms}^3)$	612	A ² s
R_{thA}	Max. thermal resistance junction to ambient ¹⁾		K/W
R_{thL}	Max. thermal resistance junction to terminals ⁴⁾	3	K/W
T_j	Operating junction temperature	- 50 ... + 185 ($T_j \leq 200^\circ\text{C}$ $V_R \leq 50\% V_{RRM}$ ⁵⁾)	°C
T_s	Storage temperature	- 50 ... + 200	°C

Characteristics		$T_A = 25^\circ\text{C}$, unless otherwise specified	
Symbol	Conditions	Values	Units
I_R	Maximum leakage current, $T_j = 25^\circ\text{C}$; $V_R = V_{RRM}$	<50	µA
	$T_j = 100^\circ\text{C}$; $V_R = V_{RRM}$	<5	mA
C_J	Typical junction capacitance (at MHz and applied reverse voltage of V)	-	pF
Q_{rr}	Reverse recovery charge ($U_R = V$; $I_F = A$; $dI_F/dt = A/\text{ms}$)	-	µC
E_{RSM}	Non repetitive peak reverse avalanche energy ($I_R = \text{mA}$; $T_j = \text{°C}$; inductive load switched off)	-	mJ

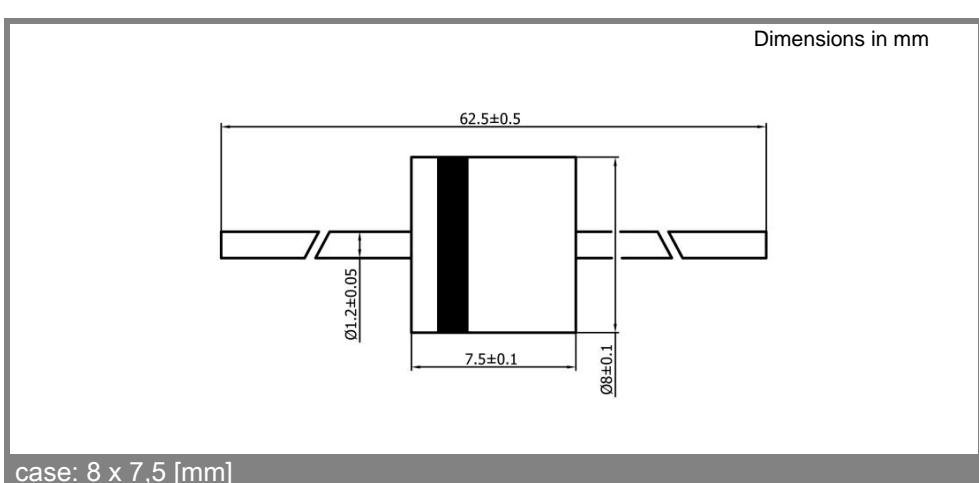
1) Valid, if leads are kept at T_A at a distance of 10 mm from case

2) $V_F < 0,48\text{V}$ @ $I_F = 5 \text{ A}$ and $V_F < 0,56 \text{ V}$ @ $I_F = 15 \text{ A}$ ($T_A = 25^\circ\text{C}$)

3) $T_A = 25^\circ\text{C}$

4) Thermal resistance from junction to lead/terminal at a distance 0 mm from case

5) Max. junction temperature $T_j \leq 200^\circ\text{C}$ in reverse mode $V_R \leq 50\% V_{RRM}$ and in bypass mode / DC forward mode



SBH 1520 ... SBH 1545

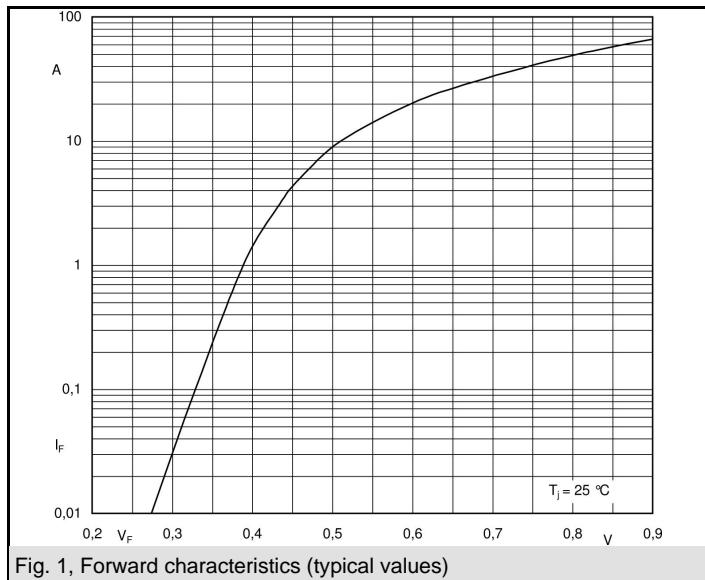


Fig. 1, Forward characteristics (typical values)

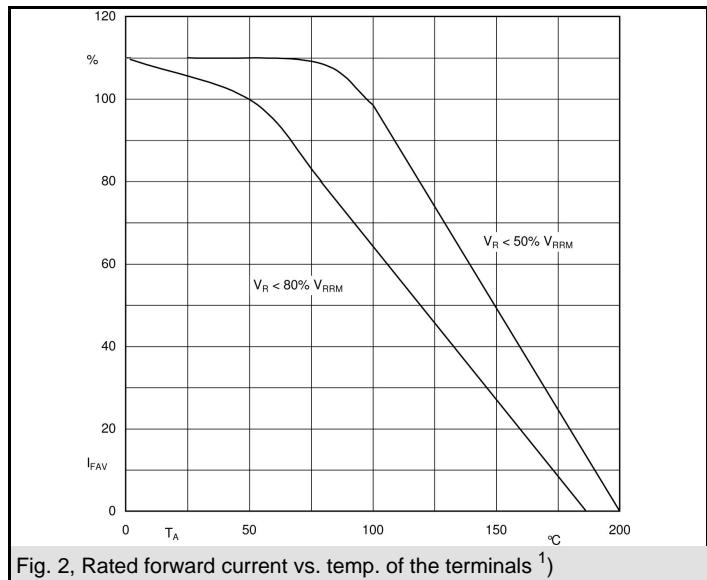


Fig. 2, Rated forward current vs. temp. of the terminals ¹⁾

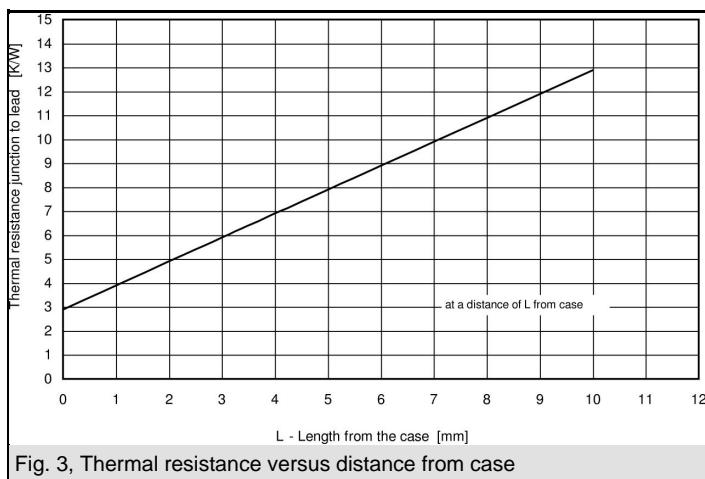


Fig. 3, Thermal resistance versus distance from case